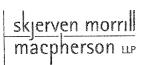


Three Embarcadero Center Suite 2800

San Francisco California 94111 T: 415-217-6000 F: 415-434-0646 Austin, TX Newport Beach, CA San Jose, CA



Docket No.: M-11443 US

August 31, 2000

Box Patent Application Commissioner For Patents Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor(s):

Smith, Lee John; Zoba, David Albert

Title:

Thin Semiconductor Package Including Stacked Dies

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This Transmittal Letter (in duplicate) page(s) Specification(not including claims)

page(s) Claims

page Abstract

Sheet(s) of Drawings (Figs. 1, 2, 3, 3a, 4, 4a, 5, 6, 7, 8, and 9) page(s) Declaration For Patent Application and Power of Attorney

page NonPublication Request

page(s) Recordation Form Cover Sheet (in duplicate)

page(s) Assignment

CLAIMS AS FILED

	Number		Number						Basic Fee	
<u>For</u>	Filed			<u>Extra</u>		Rate		\$	<u>710.00</u>	
Total Claims	25	-20	=	5	x	\$ 18.00	=	\$	90.00	
Independent Claims	5	-3	=	2	х	\$80	=	\$	160.00	
Fee of for the first filing of one or more multiple dependent claims per application								\$		
Fee for Request for Extension of Time								\$		

Please make the following charges to Deposit Account 19-2386:

☐ Total fee for filing the patent application in the amount of

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The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

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Respectfully submitted,

Robert D. Wasson

Attorney for Applicant(s)

Reg. No. 40,218

MODIFIED PTO/SB/35 (11-00)

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

Inventors Smith, Lee John; Zoba, David Albert

Title Stacked Dies

Atty Docket Number M-11443 US

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

August 31, 2001 Date

Robert D. Wasson Attorney for Applicants Reg. No.: 40,218

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

7 CFR 1 213(a) provides for a request that an application not be published under 35 U.S.C. 122(b). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. SEND TO. Commissioner for Patents, Washington, DC 20231.